SHM109HHA SERIES

1. PART NO. EXPRESSION:

SHM109HHA-1R0MF

(a) Series code

(d) Tolerance code : $M = \pm 20\%$

(a) (b)

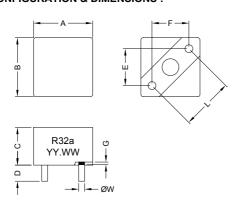
(c) (d)(e)

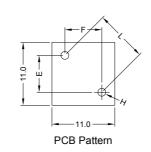
(b) Dimension code

(c) Inductance code : 1R0 = 1.00uH

(e) F: RoHS Compliant

2. CONFIGURATION & DIMENSIONS:





Unit:m/m

Series	А	В	С	D	Е	F	ØW	L	G	Н
SHM109HHA-R32MF	10.5 Max.	10.5 Max.	10.0 Max.	3.4± 0.5	5.3± 0.5	5.3± 0.5	1.4± 0.1	7.5± 0.5	0.5± 0.2	1.7 Typ.
SHM109HHA-R50MF	10.5 Max.	10.5 Max.	10.0 Max.	3.4± 0.5	5.3± 0.5	5.3± 0.5	1.4± 0.1	7.5± 0.5	0.5± 0.2	1.7 Typ.
SHM109HHA-R68MF	10.5 Max.	10.5 Max.	10.0 Max.	3.4± 0.5	5.3± 0.5	5.3± 0.5	1.3± 0.1	7.5± 0.5	0.5± 0.2	1.6 Typ.
SHM109HHA-R80MF	10.5 Max.	10.5 Max.	10.0 Max.	3.4± 0.5	5.3± 0.5	5.3± 0.5	1.3± 0.1	7.5± 0.5	0.5± 0.2	1.6 Typ.
SHM109HHA-1R0MF	10.5 Max.	10.5 Max.	10.0 Max.	3.4± 0.5	5.3± 0.5	5.3± 0.5	1.2± 0.1	7.5± 0.5	0.5± 0.2	1.5 Typ.

3. SCHEMATIC:



4. MATERIALS :

(a) Core: SF3 Alloy Powder(b) Wire: Enamelled Copper Wire(c) Solder: Sn99.95%-Cu0.05%



NOTE: Specifications subject to change without notice. Please check our website for latest information.

10.06.2011



PG. 1

SHM109HHA SERIES

5. GENERAL SPECIFICATION:

a) Test Frequency : 100KHz/1.0V b) Operating temp. : -25° C to +125° C

c) Ambient temp. : 20° C

d) Irms (A) : Will cause an approximately temp. rise $\Delta T \leq 40^{\circ}$ C

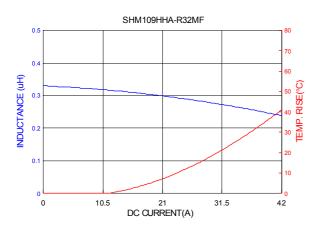
e) Isat (A): Will cause Lo to drop approximately 30%

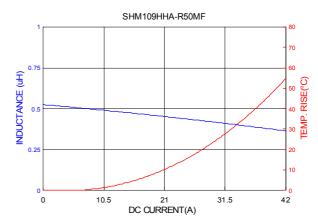
f) Part temperature (ambient + temp. rise): Should not exceed 125° C under worst case operating conditions.

6. ELECTRICAL CHARACTERISTICS:

Part No.	Inductance Lo (uH) ± 20% @ 0Adc	Irms (A) Max.	Isat (A) Max.	DCR (mΩ) ± 10%	Q Min.
SHM109HHA-R32MF	0.32	38	42	0.35	45
SHM109HHA-R50MF	0.50	35	42	0.52	45
SHM109HHA-R68MF	0.68	33	33	0.62	45
SHM109HHA-R80MF	0.80	32	32	0.80	45
SHM109HHA-1R0MF	1.00	30	25	0.92	60

7. CHARACTERISTICS CURVES:



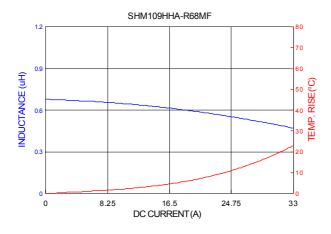


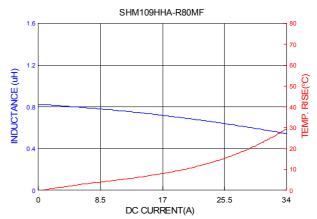


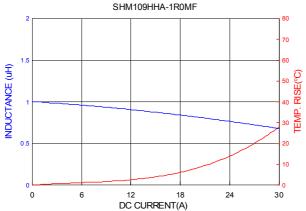
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SHM109HHA SERIES

7. CHARACTERISTICS CURVES:









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SHM109HHA SERIES

8. RELIABILITY AND TEST CONDITION:

ITEM	PERFORMANCE	TEST CONDITION		
Electrical Characteristics T	est			
Inductance	Refer to standard electrical characteristics list	HP4284A or CH3302/1320/1320S		
DCR		HIOKI3540		
Heat Rated Current (Irms)		Irms(A) will cause an temp rise ≤ 40° C typ.		
Saturation Current (Isat)		Isat(A) will cause Lo to drop approximately 30%		
Mechanical Performance T	est			
Solderability Test	More than 90% of the terminal electrode should be covered with solder.	Preheating Dipping Natural cooling 150° C 150° C Seconds After fluxing, component shall be dipped in a melted solder bath at 245± 5° C for 5 seconds		
Solder Heat Resistance	Appearance : No significant abnormality Inductance change : Within ± 10% of initial value	Preheat: 150° C, 60sec. Solder: lead free Solder Temperature: 260±5° C Flux: rosin Dip Time: 10±0.5sec. Preheating Dipping Natural cooling 150° C 150° C 10±0.5 seconds		
Reliability Test				
High Temperature Life Test		Temperature: 85± 5° C Time: 500± 12 hours Recovery: 4 to 24hrs of recovery under the standard condition after the removal from test chamber		
Low Temperature Life Test	Appearance : No damage Inductance : Within ± 10% of initial value.	Temperature : -20± 5° C Time : 500± 12 hours Recovery: 4 to 24hrs of recovery under the standard condition after the removal from test chamber		
Thermal Shock	No disconnection or short circuit.	Conditions of 1 cycle. Step Temperature (° C) Times (min.) 1		
Humidity Resistance	Appearance : No damage Inductance : Within ± 10% of initial value. No disconnection or short circuit.	Temperature: 40±5° C Humidity: 90% to 95% Applied Current: Rated Current Time: 500±12 hours Recovery: 4 to 24hrs of recovery under the standard condition after the removal from test chamber		
Random Vibration Test	Appearance: Cracking, chipping and any other defects harmful to the characteristics should not be allowed.	Frequency: 10-55-10Hz for 1 min. Amplitude: 1.52mm Directions and times: X, Y, Z directions for 2 hours. A period of 2 hours in each of 3 mutually perpendicular directions (Total 6 hours).		

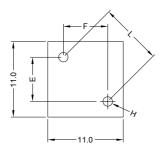
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SUPERWORLD ELECTRONICS (S) PTE LTD

Unit:m/m

9. SOLDERING AND MOUNTING:

9-1. Recommended PC Board Pattern



Series	E	F	L	Н	
SHM109HHA-R32MF	5.3± 0.5	5.3± 0.5	7.5± 0.5	1.7 Typ.	
SHM109HHA-R50MF	5.3± 0.5	5.3± 0.5	7.5± 0.5	1.7 Typ.	
SHM109HHA-R68MF	5.3± 0.5	5.3± 0.5	7.5± 0.5	1.6 Typ.	
SHM109HHA-R80MF	5.3± 0.5	5.3± 0.5	7.5± 0.5	1.6 Typ.	
SHM109HHA-1R0MF	5.3± 0.5	5.3± 0.5	7.5± 0.5	1.5 Typ.	

9-2. Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

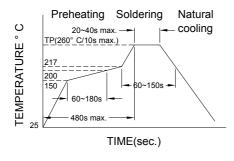
9-2.1 Solder Re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

9-2.2 Soldering Iron (Figure 2):

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- Note:
 - a) Preheat circuit and products to 150° C.
 - b) 280° C tip temperature (max)
 - c) Never contact the ceramic with the iron tip
 - d) 1.0mm tip diameter (max)
 - e) Use a 20 watt soldering iron with tip diameter of 1.0mm
 - f) Limit soldering time to 3 secs.



Preheating

Soldering

Natural

Figure 1. Re-flow Soldering

Figure 2. Iron Soldering

RoHS Compliant

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SHM109HHA SERIES

10. PACKING AND QUANTITY:

Size	SHM109HHA		
Styrofoam	120		
Inner Box	840		
Carton	1680		

Application Notice

1. Storage Conditions :

To maintain the solderability of terminal electrodes :

- a) Temperature and humidity conditions: Less than 30° C and 70% RH.
- b) Recommended products should be used within 6 months from the time of delivery.
- c) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation:

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) The use of tweezers or vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.



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